Small Signal Discretes



Never stop thinking

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# BGF121

Revision History: 2009-06-16, V2.2

Previous Version: 2009-02-25, V2.1						
Page	Subjects (major changes since last revision)					
7	Figure 5 updated for 2mm component pitch					



# **Transient Voltage Suppressor**

## Features

- 1 channel TVS diode designed for portable application
- ESD protection according to IEC61000-4-2 for ±15 kV contact discharge on all IOs
- · Wafer Level Package with SnAgCu solder balls
- RoHS and WEEE compliant package
- · Very small form factor

#### TVS

- High peak pulse power
- Stand-off voltage up to 10 V
- Low clamping voltage factor Vcl/Vbr
- Fast response time

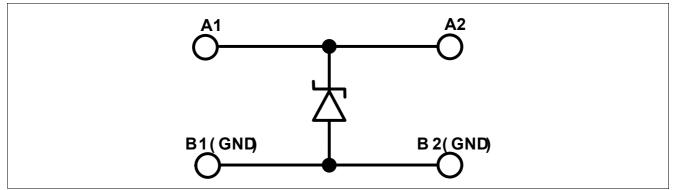


WLP-4-1-3D



### Description

The BGF121 is a single line TVS diode designed for transient voltage and power overstress suppression. All pins are protected against ESD pulses of  $\pm$ 15 kV contact discharge according to IEC61000-4-2. The wafer level package is a green package with a size of only 0.75 mm x 0.75 mm and a total height of 0.60 mm.



#### Figure 1 Schematic

Туре	Package	Marking	Chip
BGF121	WLP-4-1	21	N0743



### Table 1Maximum Ratings

Parameter	Symbol	Values			Unit	Note /
		Min.	Тур.	Max.		Test Condition
Voltage at all pins to GND	V <sub>P</sub>	0	-	10	V	-
Operating temperature range	T <sub>OP</sub>	-30	-	+85	°C	-
Storage temperature range	T <sub>STG</sub>	-55	-	+150	°C	-
Electrostatic Discharge According to IEC61000-4-2	V <sub>ESD</sub>	-15	-	15	kV	-

### Table 2 Electrical Characteristics<sup>1)</sup>

Parameter	Symbol	Values			Unit	Note /
		Min.	Тур.	Max.	_	Test Condition
Line capacitance to GND	CT		160		pF	V <sub>R</sub> = 0 V
Forward voltage	V <sub>F</sub> <sup>2)</sup>		1.1	1.3	V	I <sub>F</sub> = 850 mA
Break down voltage	V <sub>BR</sub>	16	16.9 17.7		V	$I_{\rm R}$ = 15 mA $T_{\rm A}$ = -30 °C $T_{\rm A}$ = 25 °C
Clamping voltage during transient	V <sub>CL</sub> <sup>3)</sup>		18.7	20	V	I <sub>R</sub> = 1 A, T <sub>A</sub> = 85 °C
Leakage current of line to GND	I <sub>R</sub>		1 10 100	800	nA	$V_{\rm R}$ = 10 V $T_{\rm A}$ = -30 °C $T_{\rm A}$ = 25 °C $T_{\rm A}$ = 85 °C

1) Otherwise specified at  $T_A = 25 \degree C$ 

2) To avoid high temperature and possible disassembling of component from the board, DC current operation to be limited to few seconds

3) 8/20  $\mu s$  pulse waveform according to IEC61000-4-5



**BGF121** 

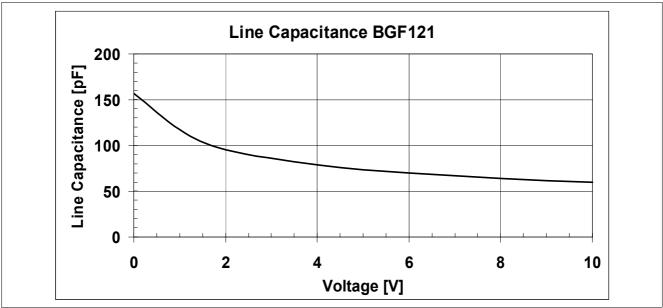


Figure 2 Line Capacitance vs reverse voltage (typical values) at 25°C

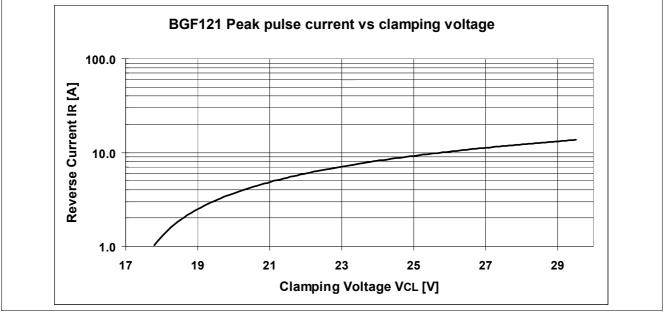
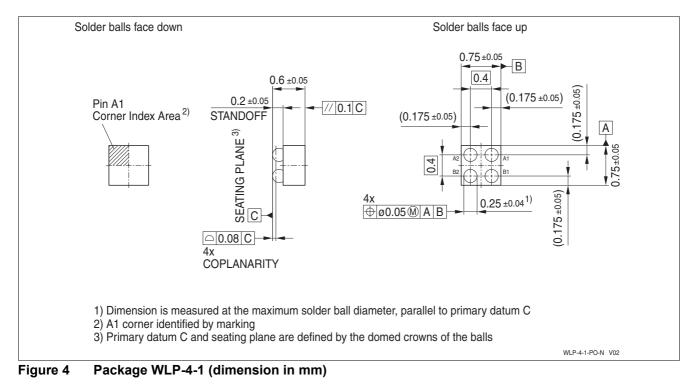


Figure 3 Peak pulse reverse current (IEC61000-4-5) versus clamping voltage (typical values) at 25°C



#### Package Outline



#### Tape and reel specification

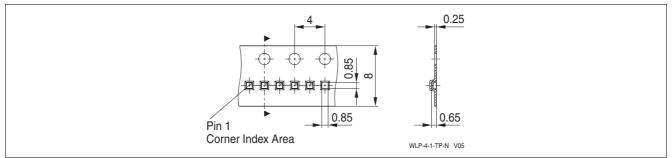


Figure 5 Tape for WLP-4-1 (dimension in mm)

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